

Silicon Power Transistors MJ15022 (NPN), MJ15024 (NPN)

The MJ15022 and MJ15024 are power transistors designed for high power audio, disk head positioners and other linear applications.

Features

- High Safe Operating Area
- High DC Current Gain
- These Devices are Pb-Free and are RoHS Compliant*
- Complementary to MJ15023 (PNP), MJ15025 (PNP)

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage MJ15022 MJ15024	V _{CEO}	200 250	Vdc
Collector-Base Voltage MJ15022 MJ15024	V _{CBO}	350 400	Vdc
Emitter-Base Voltage	V _{EBO}	5	Vdc
Collector-Emitter Voltage	V _{CEX}	400	Vdc
Collector Current - Continuous	I _C	16	Adc
Collector Current - Peak (Note 1)	I _{CM}	30	Adc
Base Current - Continuous	I _B	5	Adc
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	250 1.43	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to +200	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

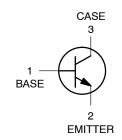
1. Pulse Test: Pulse Width = 5 ms, Duty Cycle ≤ 10%.

THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.70	°C/W

16 AMPERES SILICON POWER TRANSISTORS 200 – 250 VOLTS, 250 WATTS

SCHEMATIC





TO-204AA (TO-3) CASE 1-07 STYLE 1

MARKING DIAGRAM



MJ1502x = Device Code x = 2 or 4

G = Pb-Free Package A = Assembly Location Y = Year

WW = Work Week
MEX = Country of Origin

ORDERING INFORMATION

Device	Package	Shipping
MJ15022G	TO-204 (Pb-Free)	100 Units / Tray
MJ15024G	TO-204 (Pb-Free)	100 Units / Tray

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MJ15022 (NPN), MJ15024 (NPN)

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic			Min	Max	Unit
OFF CHARACTERISTICS				•	ı
Collector–Emitter Sustaining Voltage (Note 2) $(I_C = 100 \text{ mAdc}, I_B = 0)$	MJ15022 MJ15024	V _{CEO(sus)}	200 250	_ _	_
Collector Cutoff Current $(V_{CE} = 200 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc})$ $(V_{CE} = 250 \text{ Vdc}, V_{BE(off)} = 1.5 \text{ Vdc})$	MJ15022 MJ15024	I _{CEX}		250 250	μAdc
Collector Cutoff Current $(V_{CE} = 150 \text{ Vdc}, I_B = 0)$ $(V_{CE} = 200 \text{ vdc}, I_B = 0)$	MJ15022 MJ15024	I _{CEO}	- -	500 500	μAdc
Emitter Cutoff Current (V _{CE} = 5 Vdc, I _B = 0)		I _{EBO}	-	500	μAdc
SECOND BREAKDOWN					•
Second Breakdown Collector Current with Base Forward Biased (V _{CE} = 50 Vdc, t = 0.5 s (non-repetitive)) (V _{CE} = 80 Vdc, t = 0.5 s (non-repetitive))		I _{S/b}	5 2	_ _	Adc
ON CHARACTERISTICS				•	•
DC Current Gain $ (I_C = 8 \text{ Adc, V}_{CE} = 4 \text{ Vdc)} $ $ (I_C = 16 \text{ Adc, V}_{CE} = 4 \text{ Vdc)} $		h _{FE}	15 5	60 -	_
Collector–Emitter Saturation Voltage ($I_C = 8$ Adc, $I_B = 0.8$ Adc) ($I_C = 16$ Adc, $I_B = 3.2$ Adc)		V _{CE(sat)}	-	1.4 4.0	Vdc
Base-Emitter On Voltage (I _C = 8 Adc, V _{CE} = 4 Vdc)		V _{BE(on)}	_	2.2	Vdc
DYNAMIC CHARACTERISTICS					
Current-Gain - Bandwidth Product $(I_C = 1 \text{ Adc}, V_{CE} = 10 \text{ Vdc}, f_{test} = 1 \text{ MHz})$		f _T	4	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f _{test} = 1 MHz)		C _{ob}	-	500	pF

^{2.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2%.

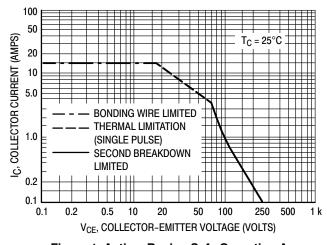


Figure 1. Active-Region Safe Operating Area

There are two limitations on the powerhandling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate I_C – V_{CE} limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

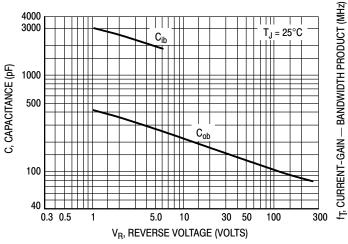
The data of Figure 1 is based on $T_{J(pk)} = 200^{\circ}C$; T_C is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power that can be handled to values Ion than the limitations imposed by second breakdown.

MJ15022 (NPN), MJ15024 (NPN)

TYPICAL CHARACTERISTICS

9

1.8



8 7 6 6 5 4 3 2 1 0.1 0.3 0.5

Figure 2. Capacitances

 $\label{eq:lc} {\it I_{C}, COLLECTOR CURRENT (AMPS)}$ Figure 3. Current–Gain — Bandwidth Product

1.0

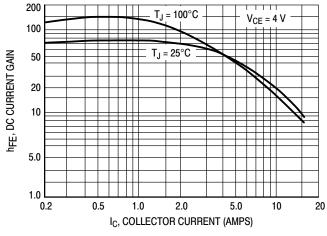
2.0

 $T_J = 25^{\circ}C$ $V_{CE} = 10 \text{ V}$

f_{Test} = 1 MHz

5.0

10



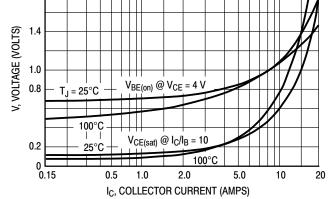


Figure 4. DC Current Gain

Figure 5. "On" Voltage

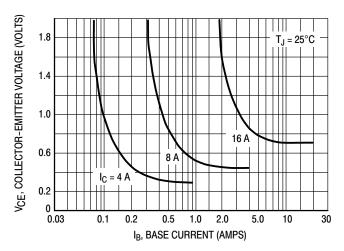
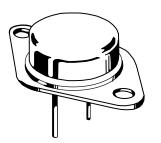


Figure 6. Collector Saturation Region

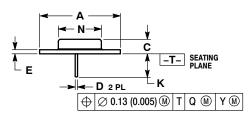


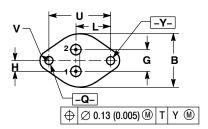


TO-204 (TO-3) CASE 1-07 ISSUE Z

DATE 10 MAR 2000

SCALE 1:1





CASE: COLLECTOR

CASE: CATHODE

NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

- 2. CONTROLLING DIMENSION: INCH.
 3. ALL RULES AND NOTES ASSOCIATED WITH
 REFERENCED TO-204AA OUTLINE SHALL APPLY.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	1.550	REF	39.37	REF
В		1.050		26.67
C	0.250	0.335	6.35	8.51
D	0.038	0.043	0.97	1.09
Е	0.055	0.070	1.40	1.77
G	0.430 BSC		10.92 BSC	
Н	0.215 BSC		5.46 BSC	
K	0.440	0.480	11.18	12.19
L	0.665 BSC		16.89 BSC	
N		0.830		21.08
Q	0.151	0.165	3.84	4.19
U	1.187 BSC		30.15 BSC	
٧	0.131	0.188	3.33	4.77

STYLE 2: PIN 1. BASE 2. COLLECTOR STYLE 3: PIN 1. GATE 2. SOURCE STYLE 5: PIN 1. CATHODE 2. EXTERNAL TRIP/DELAY CASE: ANODE STYLE 4: PIN 1. GROUND 2. INPUT STYLE 1: PIN 1. BASE 2. EMITTER CASE: COLLECTOR CASE: EMITTER CASE: DRAIN CASE: OUTPUT STYLE 6: STYLE 7: STYLE 8: STYLE 9: PIN 1. CATHODE #1 2. CATHODE #2 PIN 1. GATE 2. EMITTER PIN 1. ANODE 2. OPEN PIN 1. ANODE #1 2. ANODE #2

CASE: CATHODE

CASE: ANODE

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